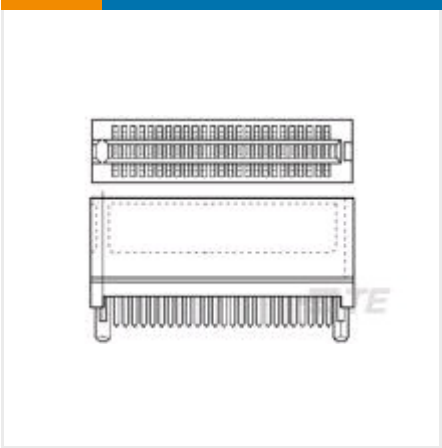




+ CONNECTORS

STANDARD EDGE CONNECTORS



✓ Active

TE CONNECTIVITY (TE)
CONNECTOR ASSEMBLY, DUAL POSITIONS, .050

[Standard Edge Connectors](#) | [Dual Connection](#) , [Standard](#)

5650719-1
TE Internal Number: 5650719-1

[EU RoHS Compliant](#)
[EU ELV Compliant](#)
Connector System Board-to-Board
Centerline (Pitch) 1.27 mm [.05 in]
Product Type Connector
Number of Dual Positions 25
Number of Rows 2

↓ **PRODUCT DRAWING**
English

↓ **3D PDF**

DOCUMENTATION

Product Drawings

CONNECTOR ASSEMBLY, END KEYED, 25 DUAL POSITION, .050 SERIES,
PDF [\(TIFF AVAILABLE\)](#)
English

CAD Files

Customer View Model
2D_DXF.ZIP
English

Customer View Model
3D_IGS.ZIP
English

Customer View Model

3D_STP.ZIP

English

3D PDF

PDF

English

Product Specifications

Application Specification

Card Edge Printed Circuit (PC) Board Connectors

PDF

English

Product Specification

Connector, Card Edge, .050 Centerline

PDF

English

Product Environmental Compliance

TE Material Declaration

MD_5650719-1_051520141448_dmtec

PDF

English

FEATURES



Please review product documents or [contact us](#) for the latest agency approval information.

Please Note: Use the Product Drawing for all design activity.

Product Type Features

- Connector System Board-to-Board
- Product Type Connector
- Connector Style Receptacle
- PCB Mounting Orientation Vertical
- Connector & Contact Terminates To Printed Circuit Board
- Type of Connector Card Edge
- Connector Type Connector Assembly
- Post Type Solder Post

Configuration Features

- Number of Dual Positions 25
- Number of Rows 2
- Selectively Loaded No

Electrical Characteristics

- Hot Pluggable No
- Operating Voltage 203 VAC

Body Features

Color Brown

Contact Features

Solder Tail Contact Plating Material Tin-Lead
Underplate Material Nickel
Contact Current Rating (Max) (A) 1
Contact Mating Area Plating Material Gold
Contact Mating Area Plating Thickness (µm) .76
Contact Termination Area Plating Material Tin-Lead
Contact Termination Area Plating Material Finish Bright
Contact Termination Area Plating Thickness 2.54 µm [100 µin]
Contact Type Socket
Contact Base Material Phosphor Bronze

Termination Features

Termination Method to PC Board Through Hole - Solder
Termination Post Length 2.54 mm [.1 in]

Mechanical Attachment

PCB Mount Alignment With
PCB Mount Retention Type Boardlocks
PCB Mount Retention With
Mating Retention Without
Mating Alignment Without

Housing Features

Centerline (Pitch) 1.27 mm [.05 in]
Housing Color Brown
Housing Material High Temperature Thermoplastic
End Caps Without

Dimensions

Height 13.97 mm [.55 in]
Card Slot Depth 7.62 mm [.3 in]
Daughter Board Thickness 1.37 – 1.78 mm [.054 – .07 in]

Usage Conditions

Operating Temperature Range (°C) -55 – 85

Packaging Features

Packaging Quantity 35
Packaging Method Box

PRODUCT COMPLIANCE



Statement of Compliance

Statement of Compliance

PDF
